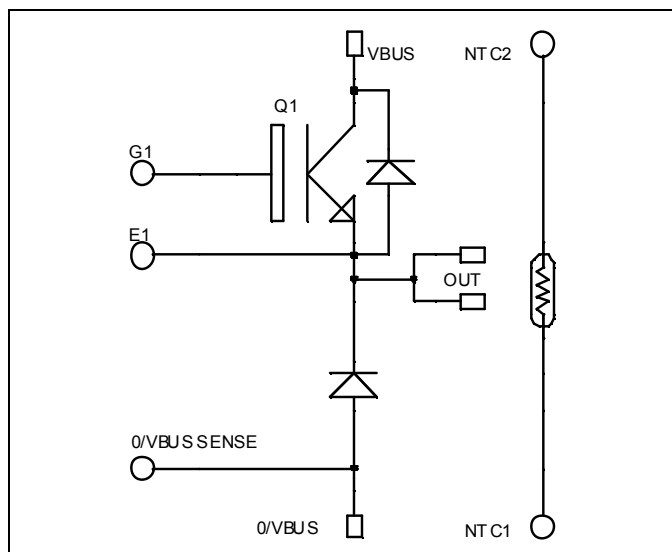


Buck chopper NPT IGBT Power Module

$V_{CES} = 600V$
 $I_C = 180A @ T_c = 80^\circ C$

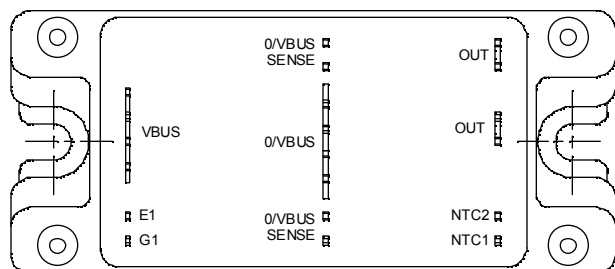


Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

- Non Punch Through (NPT) Fast IGBT®
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 100 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - Avalanche energy rated
 - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration



Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS compliant

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage	600	V
I_C	Continuous Collector Current	$T_c = 25^\circ C$ 220 $T_c = 80^\circ C$ 180	A
I_{CM}	Pulsed Collector Current	$T_c = 25^\circ C$ 630	
V_{GE}	Gate - Emitter Voltage	± 20	V
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$ 833	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^\circ C$ 400A @ 600V	



CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$ $V_{CE} = 600\text{V}$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$			300 1000	μA
$V_{CE(sat)}$	Collector Emitter saturation Voltage	$V_{GE} = 15\text{V}$ $I_C = 180\text{A}$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$		2.0 2.2	2.5	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 2\text{mA}$		3		5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20\text{V}, V_{CE} = 0\text{V}$				± 200	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0\text{V}$			8.6		nF
C_{oes}	Output Capacitance	$V_{CE} = 25\text{V}$			0.94		
C_{res}	Reverse Transfer Capacitance	$f = 1\text{MHz}$			0.8		
Q_g	Total gate Charge	$V_{GS} = 15\text{V}$			660		nC
Q_{ge}	Gate – Emitter Charge	$V_{Bus} = 300\text{V}$			580		
Q_{gc}	Gate – Collector Charge	$I_C = 180\text{A}$			400		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C)			26		ns
T_r	Rise Time	$V_{GE} = 15\text{V}$			25		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 400\text{V}$			150		
T_f	Fall Time	$I_C = 180\text{A}$ $R_G = 2.5\ \Omega$			30		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C)			26		ns
T_r	Rise Time	$V_{GE} = 15\text{V}$			25		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 400\text{V}$			170		
T_f	Fall Time	$I_C = 180\text{A}$ $R_G = 2.5\ \Omega$			40		
E_{on}	Turn-on Switching Energy	$V_{GE} = 15\text{V}$ $V_{Bus} = 400\text{V}$	$T_j = 125^\circ\text{C}$		8.6		mJ
E_{off}	Turn-off Switching Energy	$I_C = 180\text{A}$ $R_G = 2.5\ \Omega$	$T_j = 125^\circ\text{C}$		7		

Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I_{RM}	Maximum Reverse Leakage Current	$V_R = 600\text{V}$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$			350 750	μA
I_F	DC Forward Current		$T_c = 80^\circ\text{C}$		200		A
V_F	Diode Forward Voltage	$I_F = 200\text{A}$			1.6	1.8	V
		$I_F = 400\text{A}$			1.9		
		$I_F = 200\text{A}$	$T_j = 125^\circ\text{C}$		1.4		
t_{rr}	Reverse Recovery Time	$I_F = 200\text{A}$ $V_R = 400\text{V}$ $di/dt = 400\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		180		ns
			$T_j = 125^\circ\text{C}$		220		
Q_{rr}	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$		780		nC
			$T_j = 125^\circ\text{C}$		2900		

Thermal and package characteristics

Symbol Characteristic

			Min	Typ	Max	Unit
R _{thJC}	Junction to Case Thermal Resistance	IGBT			0.15	°C/W
		Diode			0.32	
V _{ISOL}	RMS Isolation Voltage, any terminal to case t=1 min, I _{isol} <1mA, 50/60Hz		2500			V
T _J	Operating junction temperature range		-40		150	°C
T _{STG}	Storage Temperature Range		-40		125	
T _C	Operating Case Temperature		-40		100	
Torque	Mounting torque	To Heatsink M5	2.5		4.7	N.m
Wt	Package Weight				160	g

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

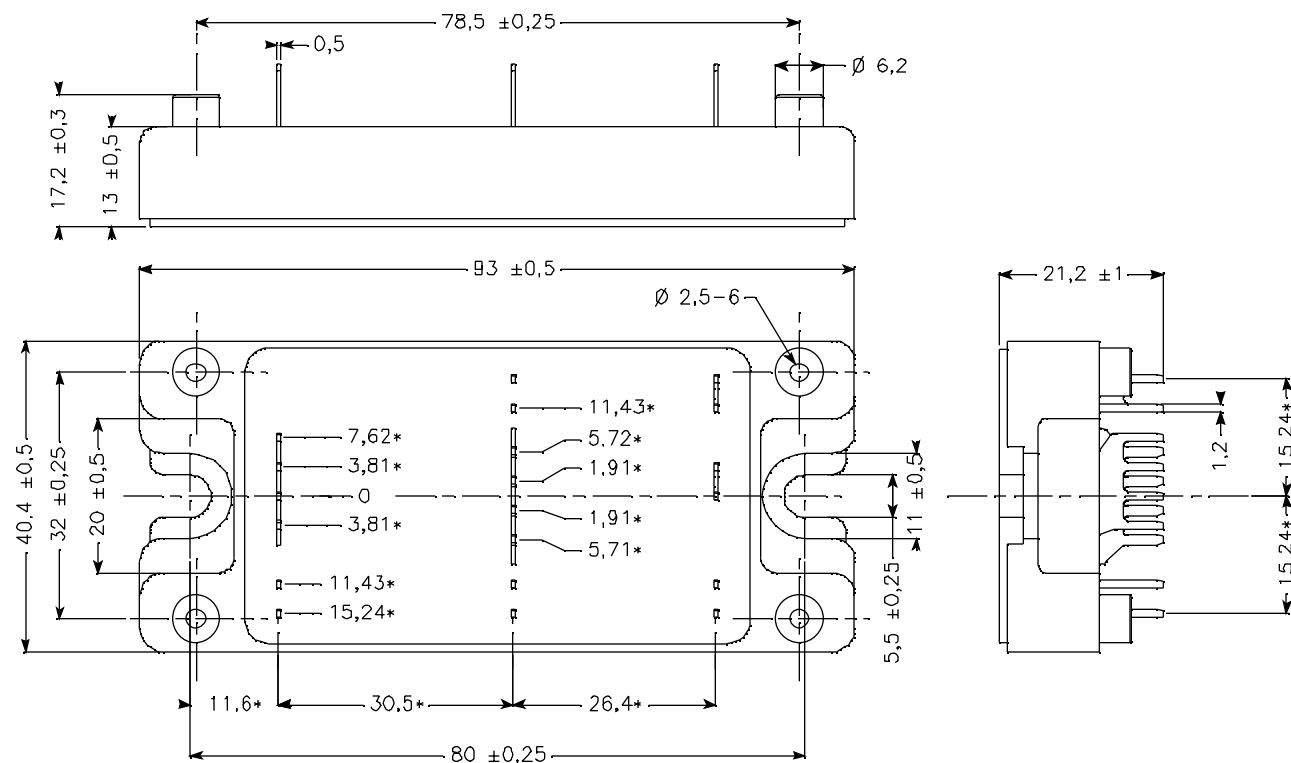
Symbol Characteristic

		Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C		50		kΩ
B _{25/85}	T ₂₅ = 298.15 K		3952		K

$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

T: Thermistor temperature
 R_T: Thermistor value at T

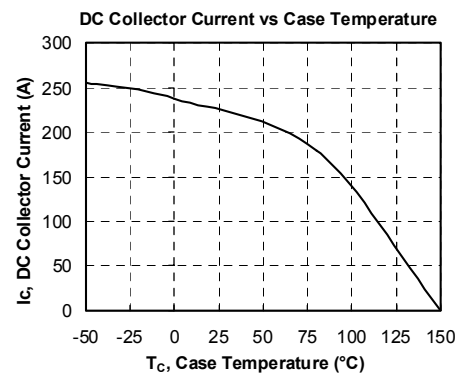
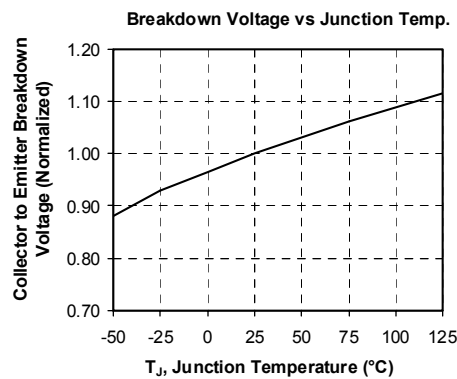
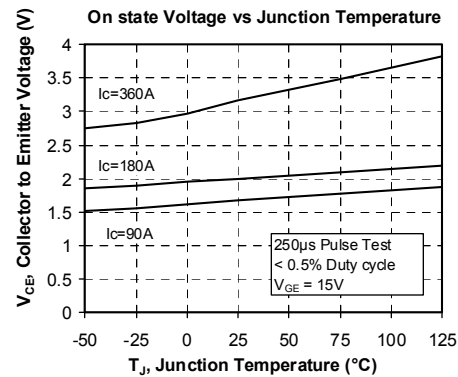
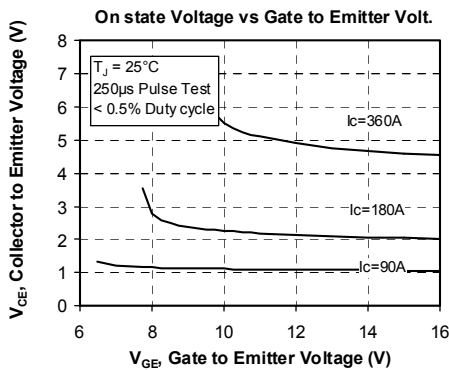
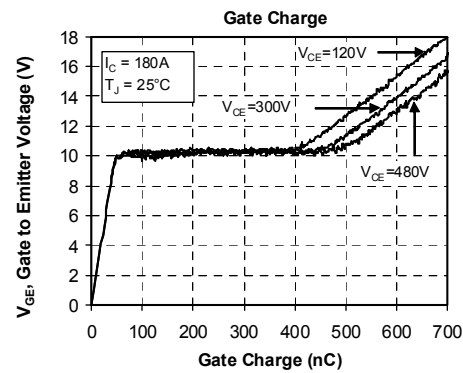
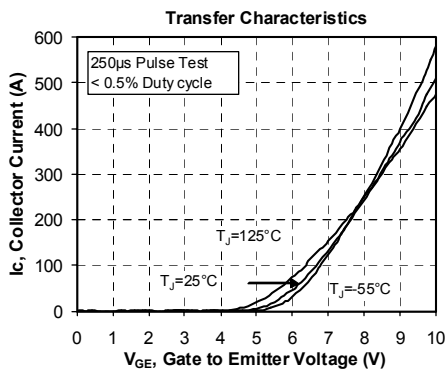
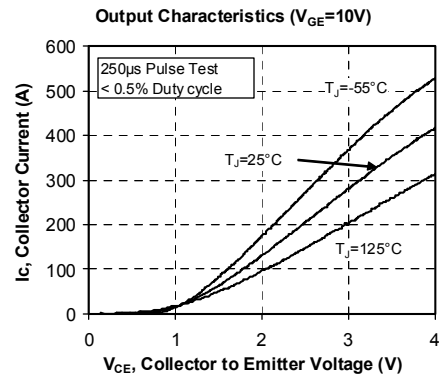
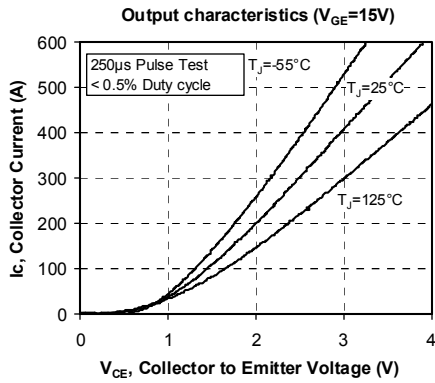
SP4 Package outline (dimensions in mm)

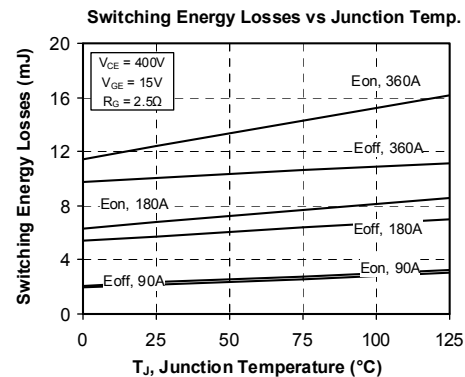
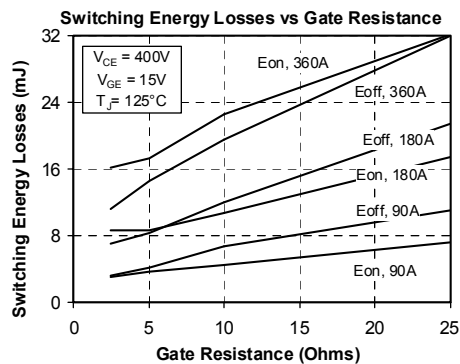
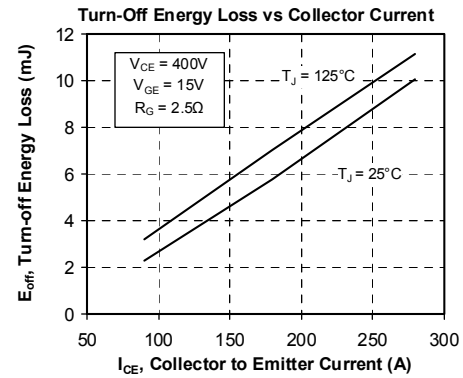
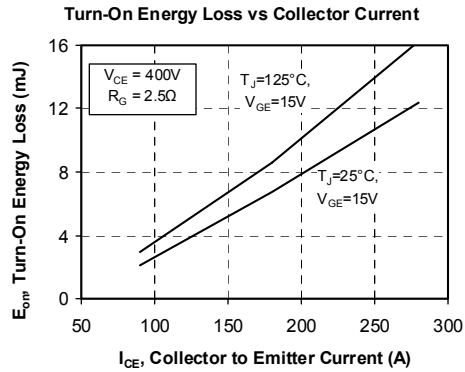
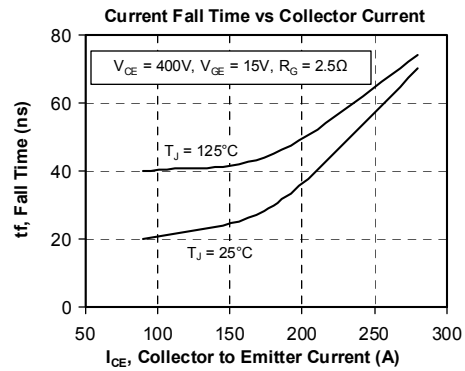
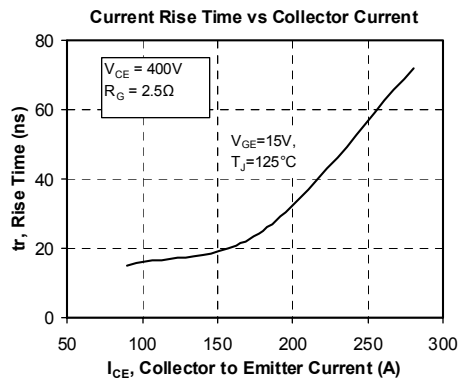
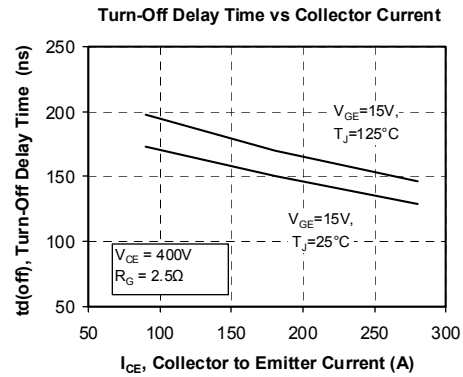
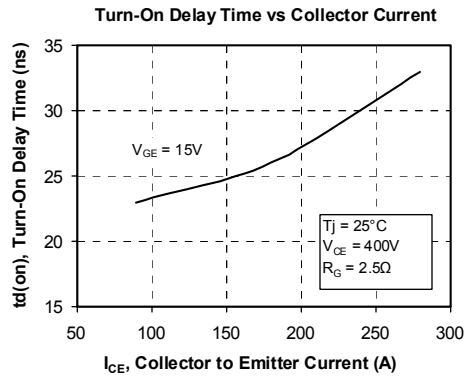


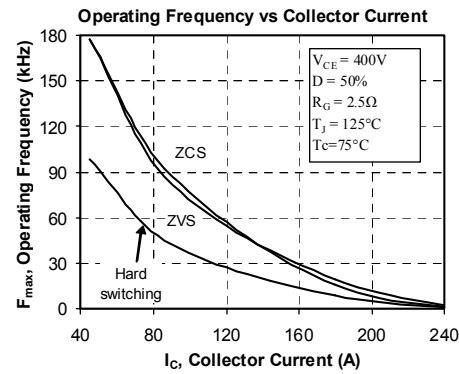
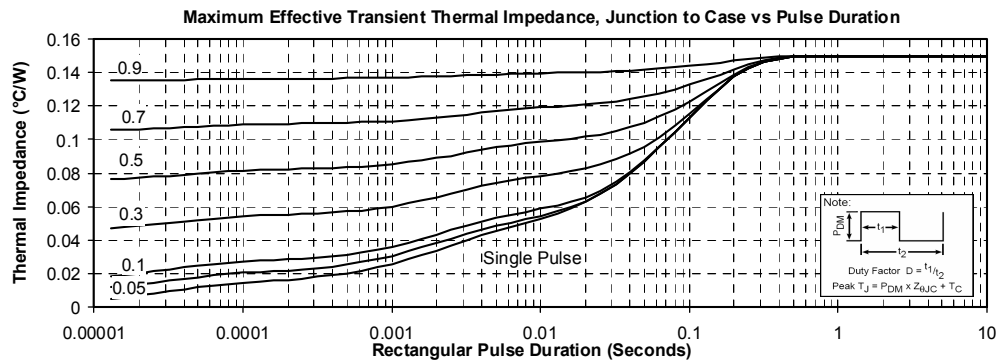
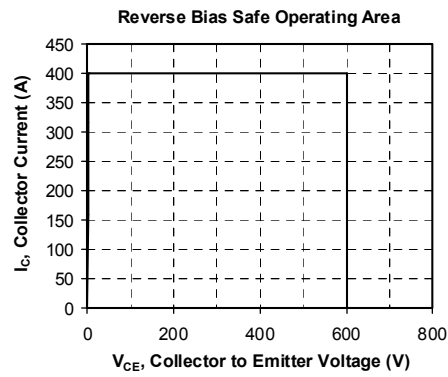
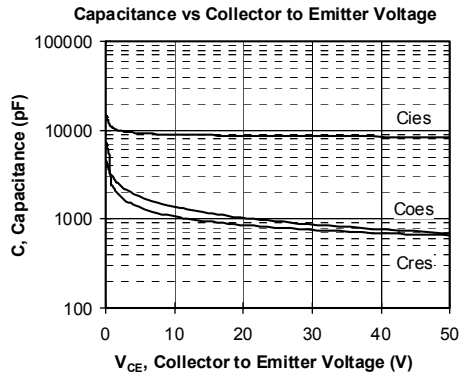
ALL DIMENSIONS MARKED "*" ARE TOLERENCED AS: $\pm \frac{\text{value}}{10}$

See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

Typical Performance Curve







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